On The Cover
The partially complete image on the cover is a two-sided four-layer PCB design that incorporates both surface mount and traditional technology. Intergraph's Tiger completed the design in 4.1 hours running on a MicroVAX II. The final design was 4"x4" with 4.61 ICs per square inch.
Image courtesy of Intergraph
Cover design by Alex Torres

Coming in April: Test Technology

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